

#### **100V N-Channel MOSFET**

### **General Description**

The 2910 uses advanced process technology and design to provide excellent RDS(ON).

This device is ideal for boost converters and synchronous rectifiers for consumer, telecom,industrial power supplies and LED backlighting.

## **Features**

- 100% avalanche tested
- Fast Switching
- Improved dv/dt capability

### **Product Summary**

BVDSS	RDSON	ID
100V	24mΩ	30A

### **Applications**

- High Efficiency Synchronous Rectification in SMPS
- Uninterruptible Power Supply
- Hard Switched and High Frequency Circuits

# TO-220/220F Pin Configuration







TO-220 (CMP2910)

TO-220F (CMF2910)

## **Absolute Maximum Ratings**

Symbol	Parameter CMP2910/CMF2910		Units	
V <sub>DS</sub>	Drain-Source Voltage 100		V	
$V_{GS}$	Gate-Source Voltage	±20		V
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current 30		30*	Α
I <sub>D</sub> @T <sub>C</sub> =100℃	Continuous Drain Current	21	21*	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>1</sup> 80 80*		80*	Α
EAS	Single Pulse Avalanche Energy <sup>2</sup>	136		mJ
P <sub>D</sub> @T <sub>C</sub> =25℃	Total Power Dissipation	50	25	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 175		$^{\circ}$ C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 175		$^{\circ}$ C

<sup>\*</sup> Drain current limited by maximum junction temperature.

#### **Thermal Data**

Symbol	Parameter	CMP2910	CMF2910	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	60	60	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-case	3	5.5	°C/W



#### 100V N-Channel MOSFET

## Electrical Characteristics ( $T_J=25^{\circ}$ C , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100			V
В	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =15A			24	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A			36	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1		3	V
	Drain-Source Leakage Current	V <sub>DS</sub> =50V , V <sub>GS</sub> =0V			1	
I <sub>DSS</sub>		$V_{DS}$ =50V , $V_{GS}$ =0V , $T_{J}$ =55 $^{\circ}{\rm C}$			5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS} = \pm 10V$ , $V_{DS} = 0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =15A		18		S
Qg	Total Gate Charge	I <sub>D</sub> =20A		15		
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =50V		4		nC
$Q_gd$	Gate-Drain Charge	V <sub>GS</sub> =10V		3		
$T_{d(on)}$	Turn-On Delay Time	V <sub>DS</sub> =50V		8		
T <sub>r</sub>	Rise Time	Rgen=3Ω		10		ns
$T_{d(off)}$	Turn-Off Delay Time	R <sub>L</sub> =2.5Ω Vgs=10V		25		115
$T_f$	Fall Time			5		
C <sub>iss</sub>	Input Capacitance			1400		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =50V , V <sub>GS</sub> =0V , f=1MHz		100		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			10		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	-V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			30	Α
I <sub>SM</sub>	Pulsed Source Current				80	Α
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =15 A , T <sub>J</sub> =25℃			1	V

#### Note:

This product has been designed and qualified for the counsumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserver the right to improve product design ,functions and reliability wihtout notice.

<sup>1.</sup> Repetitive rating, pulse width limited by junction temperature TJ(MAX)=175℃. Ratings are based on low frequency and duty cycles to keep initial TJ =25℃.

<sup>2.</sup> The EAS data shows Max. rating . The test condition is VDD=50V,VGS=10V,L=1mH,IAS=16.5A